



SMALL SIGNAL SCHOTTKY DIODE

FEATURES AND BENEFITS

- VERY SMALL CONDUCTION LOSSES
- NEGLIGIBLE SWITCHING LOSSES
- LOW FORWARD VOLTAGE DROP
- EXTREMELY FAST SWITCHING
- SURFACE MOUNTED DEVICE

DESCRIPTION

Schottky barrier diode encapsulated in a SOD-323 small SMD package.

This device is intended for use in portable equipments. It is suited for DC to DC converters, step-up conversion and power management.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage	10	٧	
lF	Peak forward current $\delta = 0.11$		3	Α
I _{FSM}	Surge non repetitive forward current tp=10ms Power Dissipation Ta=25°C		5	Α
P _{tot}			310	mW
T _{stg}	Storage temperature range	- 65 to +150	°C	
Tj	Maximum operating junction temperature *	150	°C	
TL	Maximum temperature for soldering during 10s	260	°C	

* :
$$\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$$
 thermal runaway condition for a diode on its own heatsink

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R _{th (j-a)}	Junction to ambient (*)	400	°C/W

^(*) Mounted on epoxy board with recommended pad layout.

January 2003 - Ed: 6A 1/5

BAT60J

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Tests Conditions	Tests conditions		Min.	Тур.	Max.	Unit
V _F *	Forward voltage drop	Tj = 25°C	I _F = 10 mA		0.28	0.32	٧
			I _F = 100 mA		0.35	0.40	
			I _F = 1 A		0.53	0.58	
I _R **	Reverse leakage current	Tj = 25°C	V _R = 5 V		1	3	μΑ
		Tj = 25°C	V _R = 8 V		1.3	4	
		Tj = 25°C	V _R = 10 V		2	6	
		Tj = 25°C	V _R = 12 V		2.5	7.5	
		Tj = 80°C	V _R = 8 V		73	150	

To evaluate the conduction losses the following equation:

 $P = 0.38 \text{ x } I_{F(AV)} + 0.17 I_{F^2(RMS)}$

Fig. 1: Average forward power dissipation versus average forward current.

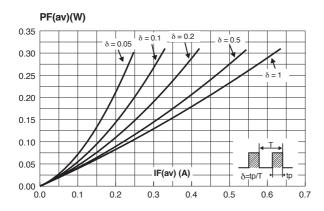


Fig. 2-2: Average forward current versus ambient temperature ($\delta = 0.5$).

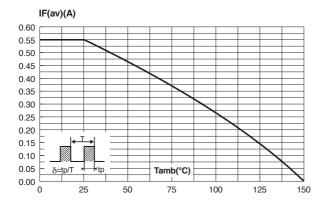


Fig. 4: Relative variation of thermal impedance junction to ambient versus pulse duration (Epoxy printed circuit board FR4 with recommended pad layout).

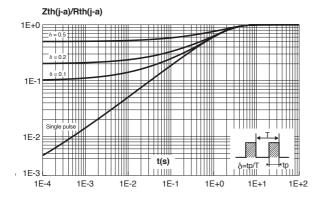


Fig. 2-1: Peak forward current versus ambient temperature ($\delta = 0.11$).

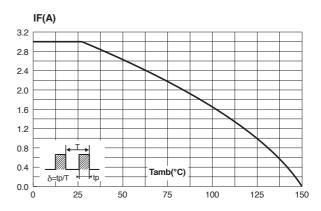


Fig. 3: Non repetitive surge peak forward current versus overload duration (maximum values).

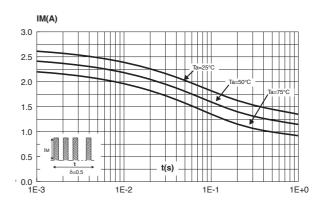
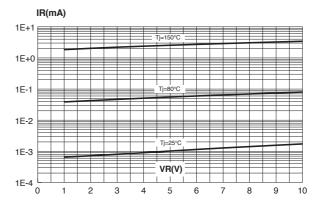


Fig. 5: Reverse leackage current versus reverse voltage applied (typical values).



47/

Fig. 6: Reverse leackage current versus junction temperature (typical values).

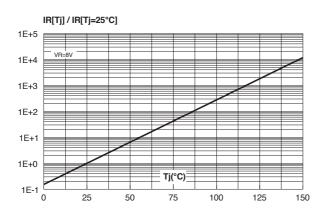


Fig. 8-1: Forward voltage drop versus forward current (High level).

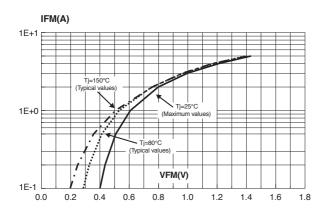
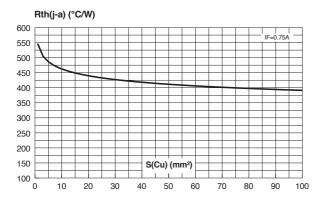


Fig. 9: Thermal resistance junction to ambient versus copper surface (epoxy printed circuit board FR4, copper thickness: $35\mu m$).



4/5

Fig. 7: Junction capacitance versus reverse voltage applied (typical values).

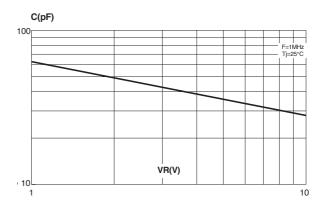
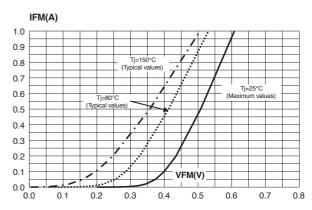
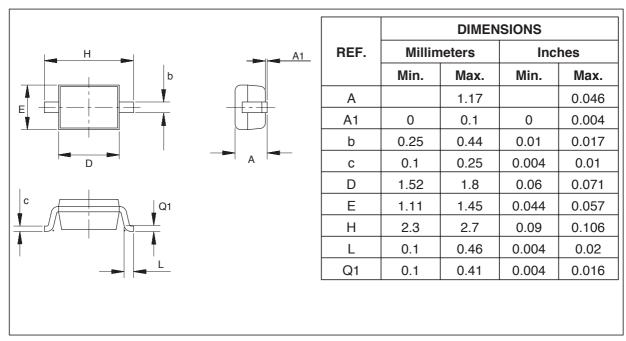


Fig. 8-2: Forward voltage drop versus forward current (Low level).



PACKAGE MECHANICAL DATA

SOD-323



MARKING

Туре	Marking	Package	Weight	Base qty	Delivery mode
BAT60JFILM	60	SOD-323	0.005 g.	3000	Tape & reel

■ Epoxy meets UL94V-0

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied.

change without notice. This publication supersedes and replaces all information previously supplied.

STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics

© 2003 STMicroelectronics - Printed in Italy - All rights reserved.

STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - Finland - France - Germany Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore

Spain - Sweden - Switzerland - United Kingdom - United States.

http://www.st.com